



**PATENT APPLICATION**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

In re application of

Docket No: Q68281

Hui ZHONG, et al.

Appln. No.: 10/049,270

Confirmation No.: 9445

Group Art Unit: 2841

Filed: February 11, 2002

Examiner: Tuan T. DINH

For: MULTILAYERED PRINTED CIRCUIT BOARD, SOLDER RESIST COMPOSITION,  
MULTILAYERED PRINTED CIRCUIT BOARD MANUFACTURING METHOD, AND  
SEMICONDUCTOR DEVICE

**AMENDMENT UNDER 37 C.F.R. § 1.114(c)**

**MAIL STOP RCE**

Commissioner for Patents

P.O. Box 1450

Alexandria, VA 22313-1450

Sir:

In response to the Office Action dated August 8, 2006, please amend the above-identified application as follows on the accompanying pages. This Amendment is filed concurrently with a Petition for Extension of Time, extending the time for responding to the Office Action of August 8, 2006 to February 8, 2007, and making this Amendment timely filed.

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